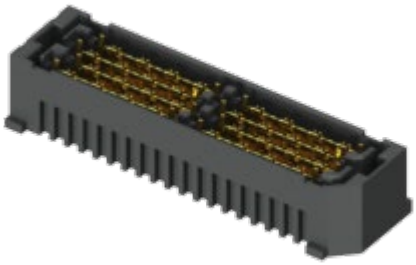
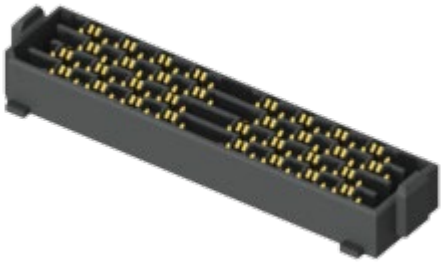
High Speed Characterization Report

NVAM-DP-XX-2-02.0-S-X-X



NVAF-DP-XX-2-05.0-S-X



Description:
0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Mated Stack Height

Samtec Inc.
520 Park East Blvd.
New Albany IN 47151-1147 USA

WWW.SAMTEC.COM
1-800-SAMTEC-9 (US & Canada)
SIG@samtec.com

Phone: 812-944-6733
Fax: 812-948-5047
Report Revision: 8/02/2023

Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Table of Contents

Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

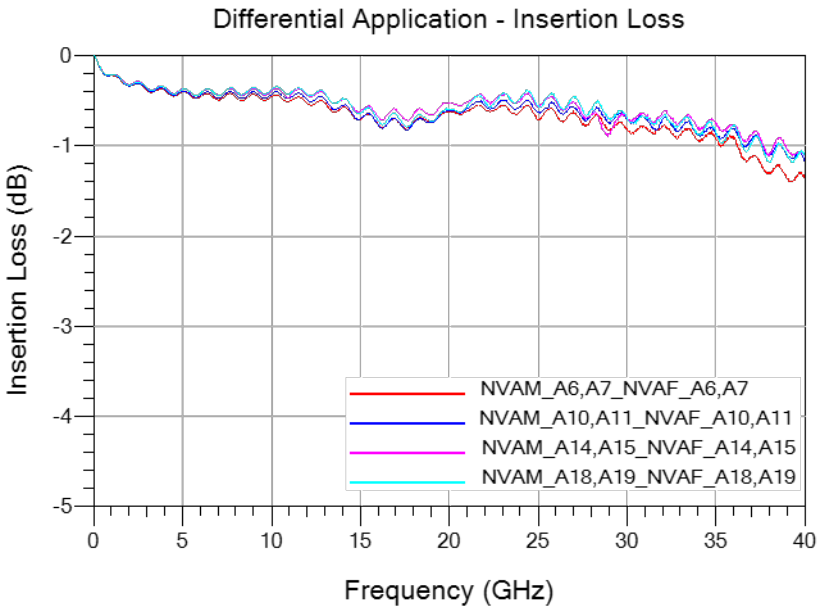
Connector Overview

The NVAx series is 0.80 mm NovaRay® Extreme Density & Performance Connector NVAM mating to NVAF Connector. NVAx series is available in 2,3 or 4 rows,1 or 2 banks with up to 16 pairs/bank, and 7 and 10 mm stack heights are characterized. This report only specific to a mated 7mm stack height NVAM/NVAF test system.

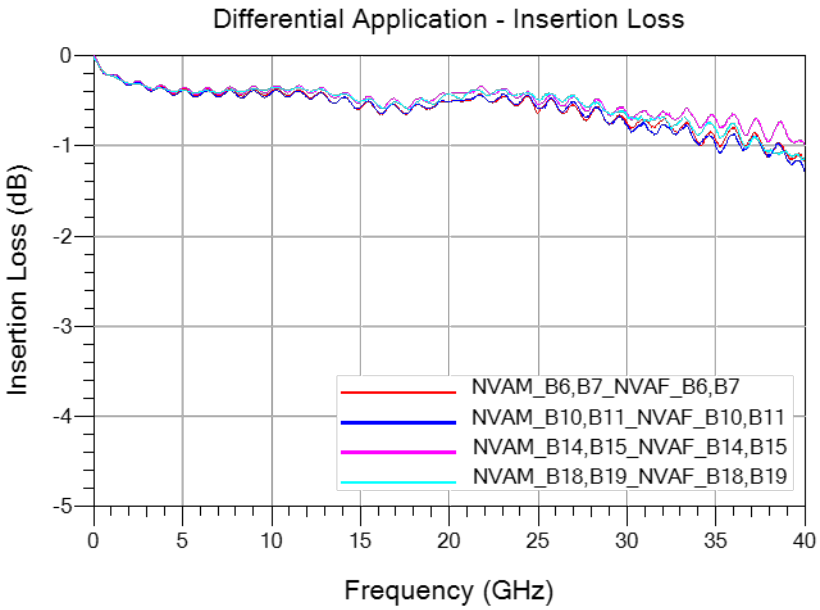
Frequency Domain Data Summary

Bandwidth Chart – Differential Insertion Loss

NVAx Connector Series



Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height



Time Domain Data Summary

Table 1 - Differential Impedance (Ω)				
Driver	**Signal Rise-time**	**30ps**	**50ps**	**100ps**
NVAM_A6, A7	Maximum Impedance	94.2	94.1	93.8
	Minimum Impedance	88.4	89.7	90.6
NVAM_A10, A11	Maximum Impedance	94.3	94.2	93.9
	Minimum Impedance	88.3	89.6	90.5
NVAM_A14, A15	Maximum Impedance	94.2	94.1	93.9
	Minimum Impedance	88.6	89.9	90.7
NVAM_A18, A19	Maximum Impedance	93.9	93.9	93.6
	Minimum Impedance	87.1	88.7	89.9
NVAM_B6, B7	Maximum Impedance	94.2	94.1	93.9
	Minimum Impedance	88.6	89.8	90.7
NVAM_B10, B11	Maximum Impedance	94.3	94.2	94.0
	Minimum Impedance	88.9	89.9	90.7
NVAM_B14, B15	Maximum Impedance	94.3	94.2	94.0
	Minimum Impedance	88.9	89.9	90.7
NVAM_B18, B19	Maximum Impedance	94.0	93.9	93.7
	Minimum Impedance	88.5	89.7	90.7

Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Table 2 - Differential Crosstalk (%)					
Input(tr)	**Driver**	**Receiver**	**30ps**	**50ps**	**100ps**
NEXT	NVAM_B6, B7	NVAM_A10, A11	<0.1	<0.1	<0.1
	NVAM_B10, B11	NVAM_A10, A11	<0.1	<0.1	<0.1
	NVAM_B14, B15	NVAM_A10, A11	<0.1	<0.1	<0.1
	NVAM_A18, A19	NVAM_A14, A15	<0.1	<0.1	<0.1
	NVAM_B18, B19	NVAM_A14, A15	<0.1	<0.1	<0.1
FEXT	NVAF_A6, A7	NVAM_A10, A11	<0.1	<0.1	<0.1
	NVAF_A14, A15	NVAM_A10, A11	<0.1	<0.1	<0.1
	NVAF_B6, B7	NVAM_A10, A11	<0.1	<0.1	<0.1
	NVAF_B10, B11	NVAM_A10, A11	<0.1	<0.1	<0.1
	NVAF_B14, B15	NVAM_A10, A11	<0.1	<0.1	<0.1

Table 3 - Propagation Delay (Mated Connector)	
NVAM_A6, A7_ NVAF_A6, A7	74 ps
NVAM_A10, A11_ NVAF_A10, A11	74 ps
NVAM_A14, A15_ NVAF_A14, A15	73 ps
NVAM_A18, A19_ NVAF_A18, A19	73 ps
NVAM_B6, B7_ NVAF_B6, B7	74 ps
NVAM_B10, B11_ NVAF_B10, B11	74 ps
NVAM_B14, B15_ NVAF_B14, B15	73 ps
NVAM_B18, B19_ NVAF_B18, B19	73 ps

Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Characterization Details

This report presents data that characterizes the signal integrity response of a connector pair in a controlled printed circuit board (PCB) environment. All efforts are made to reveal typical best-case responses inherent to the system under test (SUT).

In this report, the SUT includes the connector pair and footprint effects on a typical multi-layer PCB. PCB effects (trace loss) are de-embedded from test data. Board related effects, such as pad-to-ground capacitance, are included in the data presented in this report.

Additionally, intermediate test signal connections can mask the connector's true performance. Such connection effects are minimized by using high performance test cables and adapters. Where appropriate, calibration and de-embedding routines are also used to reduce residual effects.

Differential and Single-Ended Data

Most Samtec connectors can be used successfully in both differential and single-ended applications. However, electrical performance will differ depending on the signal drive type. In this report, data is presented for both differentially and single-ended driven scenarios.

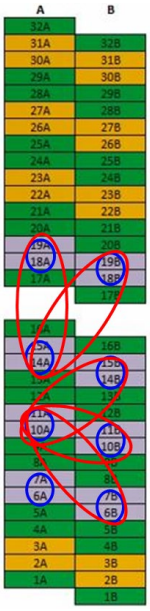
Connector Signal to Ground Ratio

Samtec connectors are most often designed for generic applications and can be implemented using various signal and ground pin assignments. In high speed systems, provisions must be made in the interconnect for signal return currents. Such paths are often referred to as "ground". In some connectors, a ground plane or blade, or an outer shield, is used as the signal return, while in others, connector pins are used as signal returns. Various combinations of signal pins, ground blades, and shields can also be utilized. Electrical performance can vary significantly depending upon the number and location of ground pins.

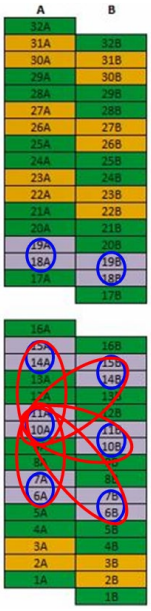
In general, the more pins dedicated to ground, the better electrical performance will be. But dedicating pins to ground reduces signal density of a connector. Therefore, care must be taken when choosing signal/ground ratios in cost or density-sensitive applications.

Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

For this connector, the following configurations were evaluated:



Potential NEXT aggressors, depending on pinout



Potential FEXT aggressors, depending on pinout

Differential Impedance (denoted by blue circles):

- GSSG (Ground-positive Signal-negative Signal-Ground)

Differential Crosstalk (denoted by red circles):

- In row: from the terminals to the other terminals on the same row.
- Across row: from one row of terminals to the other row of terminals.

Other configurations can be evaluated upon request. Please contact sig@samtec.com for more information.

In a real system environment, active signals might be located at the outer edges of the signal contacts of concern, as opposed to the ground signals utilized in laboratory testing. For example, in a single-ended system, a pin-out of “SSSS”, or four adjacent single ended signals might be encountered as opposed to the “GSG” and “GSSG” configurations tested in the laboratory. Electrical characteristics in such applications could vary slightly from laboratory results. But in most applications, performance can safely be considered equivalent.

Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Signal Edge Speed (Rise Time):
In pulse signaling applications, the perceived performance of the interconnect can vary significantly depending on the edge rate or rise time of the exciting signal. For this report, the fastest rise time used was 30 ps. Generally, this should demonstrate worst-case performance.

In many systems, the signal edge rate will be significantly slower at the connector than at the driver launch point. To estimate interconnect performance at other edge rates, data is provided for several rise times between 30 ps and 100 ps.

For this report, measured rise times were at 20%-80% signal levels.

Frequency Domain Data
Frequency Domain parameters are helpful in evaluating the connector system's signal loss and crosstalk characteristics across a range of sinusoidal frequencies. In this report, parameters presented in the Frequency Domain are Insertion Loss, Return Loss, and Near-End and Far-End Crosstalk. Other parameters or formats, such as VSWR or S-Parameters, may be available upon request. Please contact our Signal Integrity Group at sig@samtec.com for more information.

Frequency performance characteristics for the SUT are generated directly from network analyzer measurements.

Time Domain Data
Time Domain parameters indicate Impedance mismatch versus length, signal propagation time, and crosstalk in a pulsed signal environment. The measured S-Parameters from the network analyzer are post-processed using Keysight Advanced Design System to obtain the time domain response. Time Domain procedure is provided in Appendix E of this report. Parameters or formats not included in this report may be available upon request. Please contact our Signal Integrity Group at sig@samtec.com for more information.

In this report, propagation delay is defined as the signal propagation time through the connector and connector footprint. It includes 2.937 mm of PCB trace on both the NVAM and NVAF each. Delay is measured at 100 picoseconds signal risetime. Delay is calculated as the difference in time measured between the 50% amplitude levels of the input and output pulses.

Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Crosstalk or coupled noise data is provided for various signal configurations. All measurements are single disturber. Crosstalk is calculated as a ratio of the input line voltage to the coupled line voltage. The input line is sometimes described as the active or drive line. The coupled line is sometimes described as the quiet or victim line. Crosstalk ratio is tabulated in this report as a percentage. Measurements are made at both the near-end and far-end of the SUT.

Data for other configurations may be available. Please contact our Signal Integrity Group at sig@samtec.com for further information.

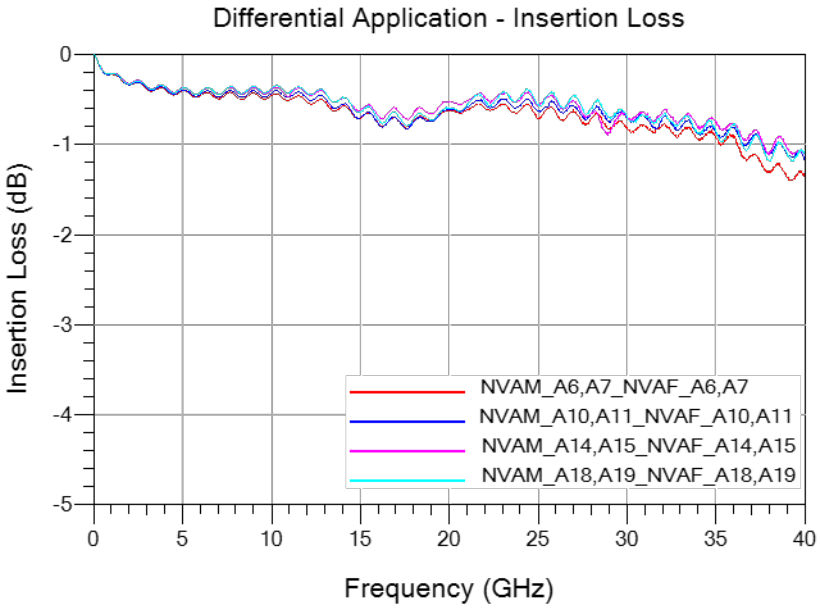
As a rule of thumb, 10% crosstalk levels are often used as a general first pass limit for determining acceptable interconnect performance. But modern system crosstalk tolerance can vary greatly. For advice on connector suitability for specific applications, please contact our Signal Integrity Group at sig@samtec.com.

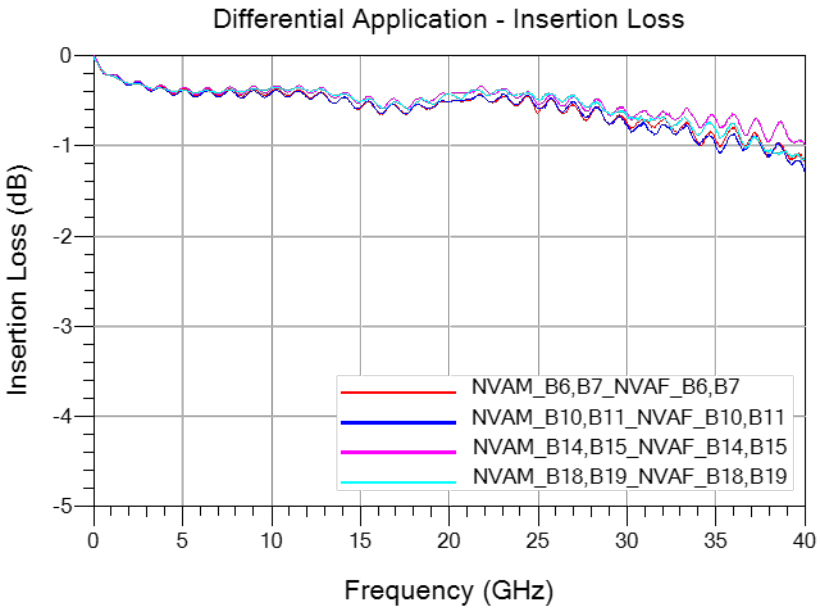
Additional information concerning test conditions and procedures is located in the appendices of this report. Further information may be obtained by contacting our Signal Integrity Group at sig@samtec.com.

Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Appendix A – Frequency Domain Responses

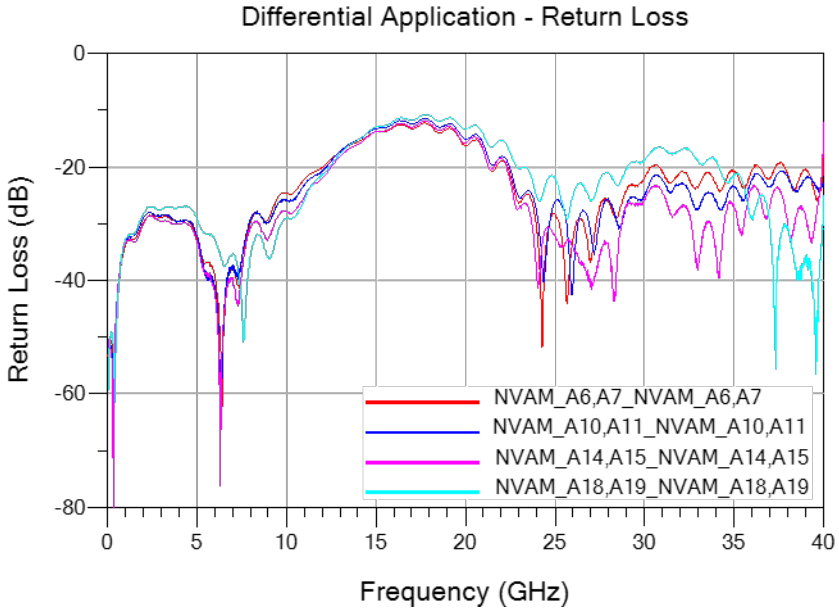
Differential Application – Insertion Loss

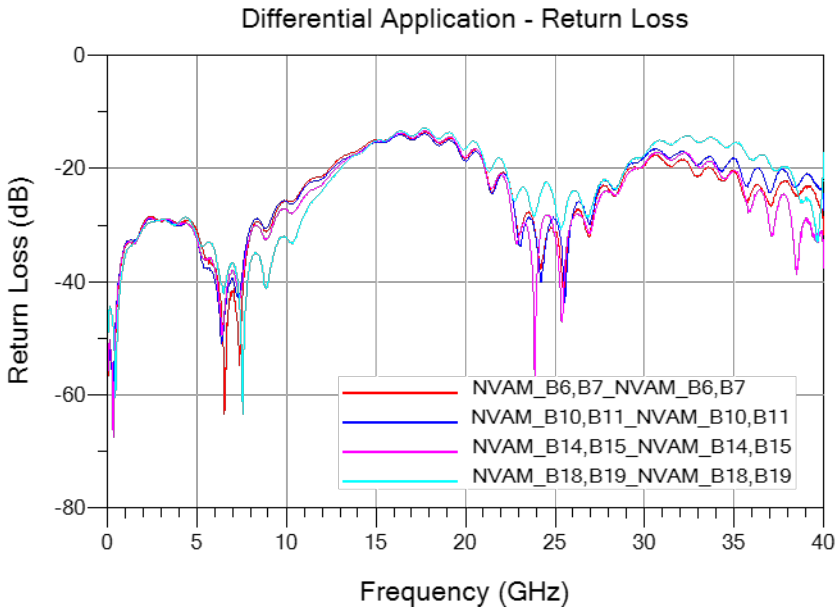




Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

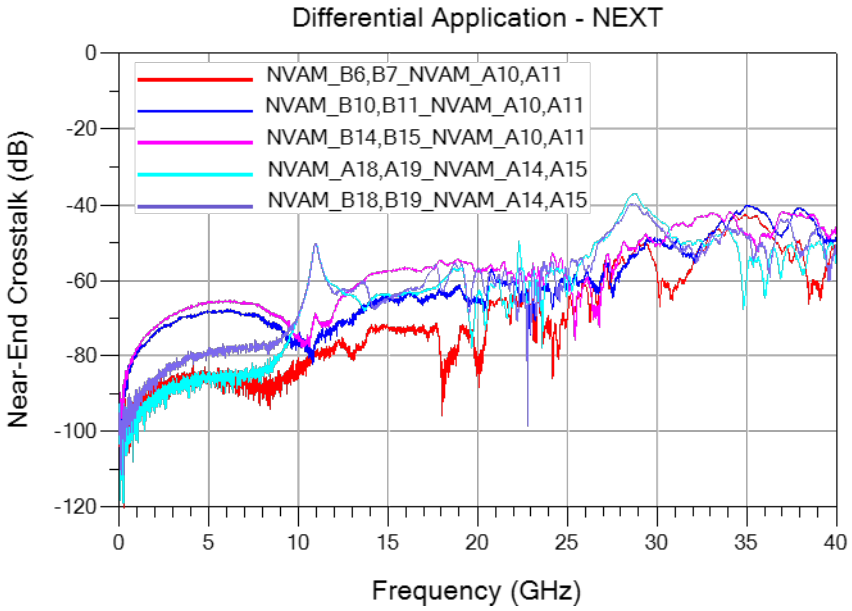
Differential Application – Return Loss



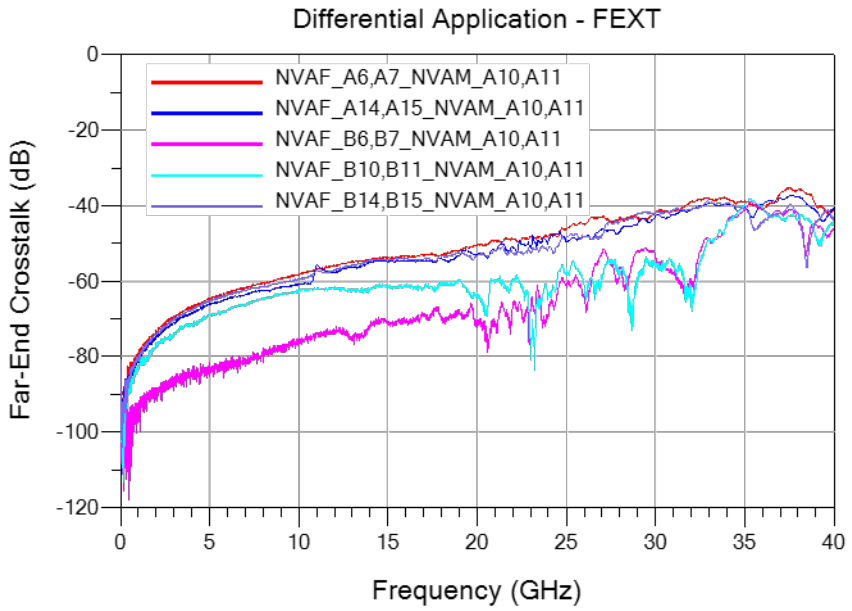


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Differential Application – NEXT Configurations



Differential Application – FEXT Configurations

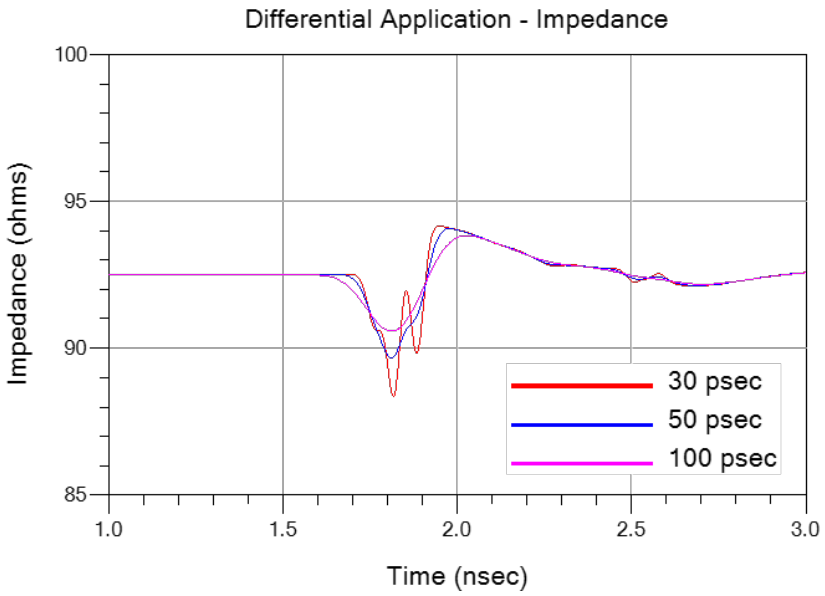


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

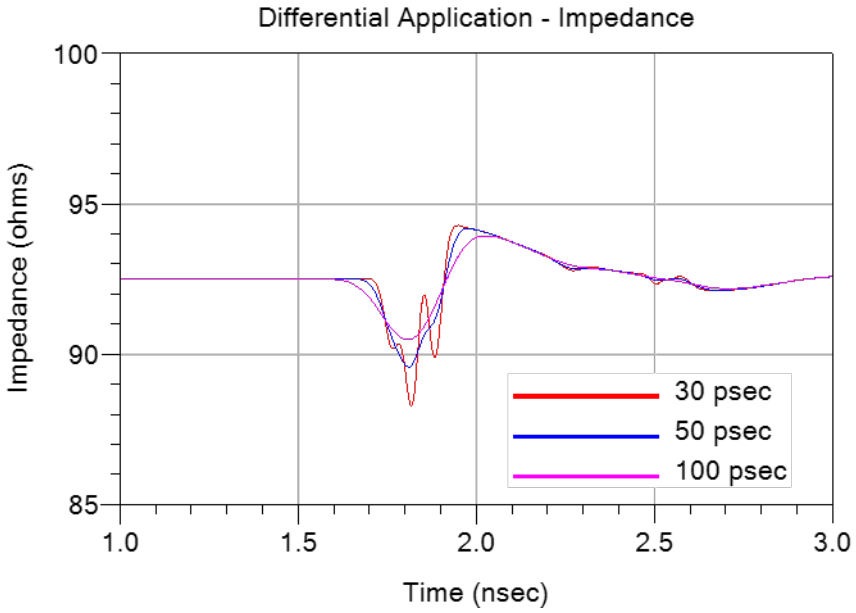
Appendix B – Time Domain Responses

Differential Application – Impedance

NVAM_A6, A7_ NVAF_A6, A7

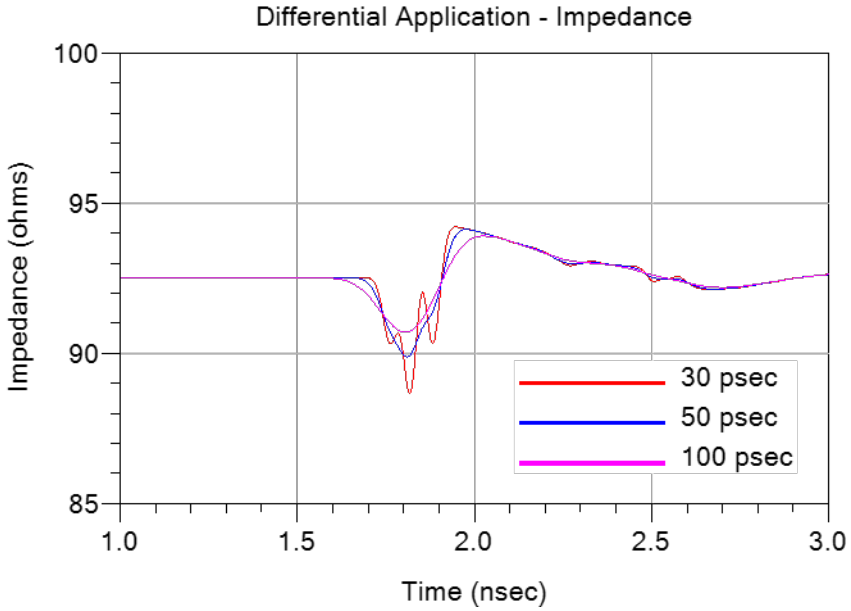


NVAM_A10, A11_ NVAF_A10, A11

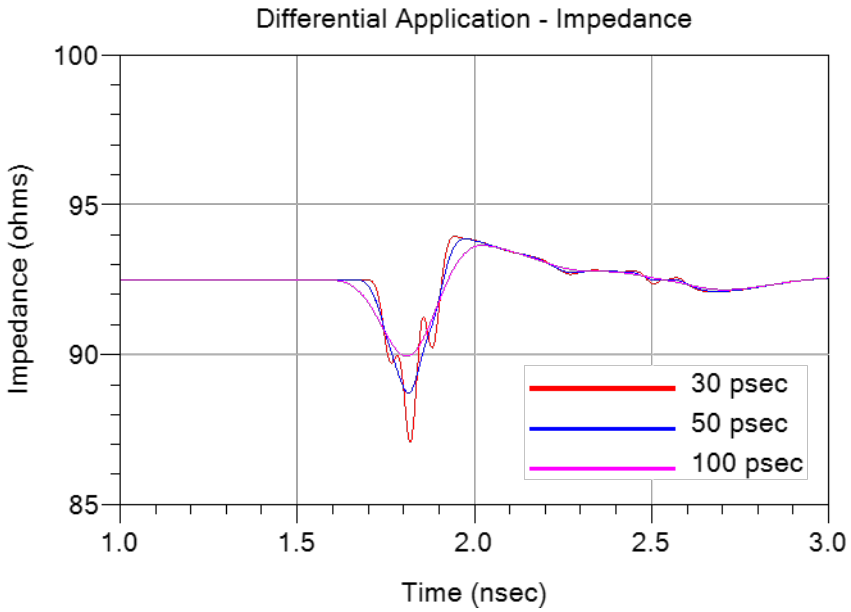


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

NVAM_A14, A15_ NVAF_A14, A15

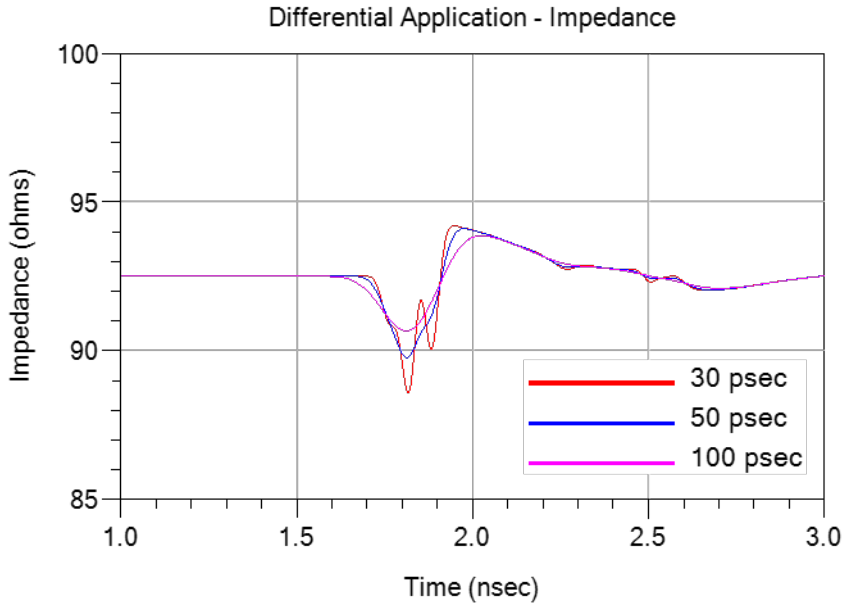


NVAM_A18, A19_ NVAF_A18, A19

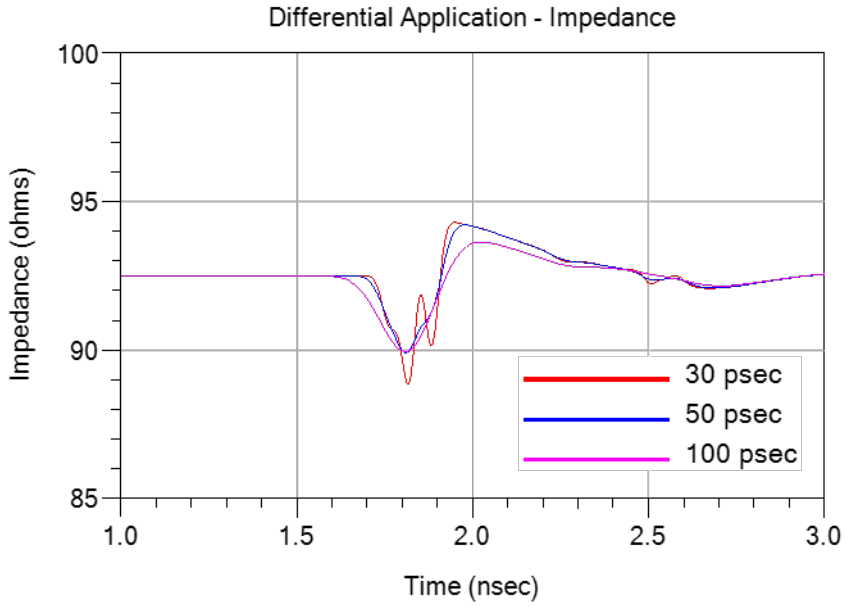


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

NVAM_B6, B7_ NVAF_B6, B7

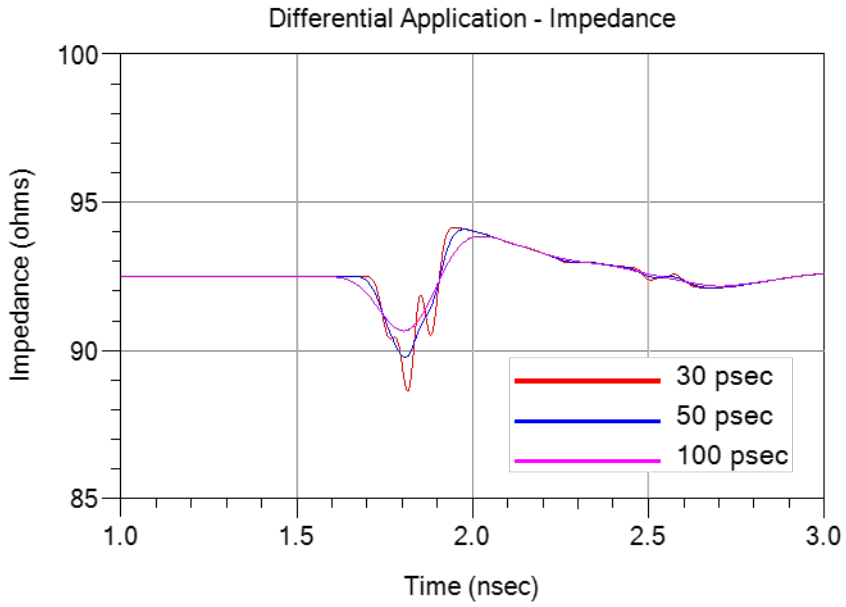


NVAM_B10, B11_ NVAF_B10, B11

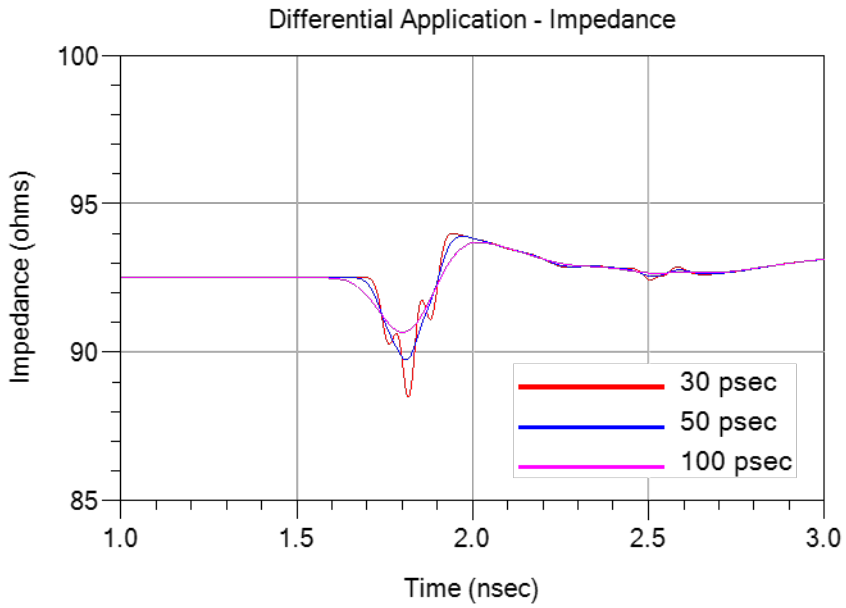


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

NVAM_B14, B15_ NVAF_B14, B15



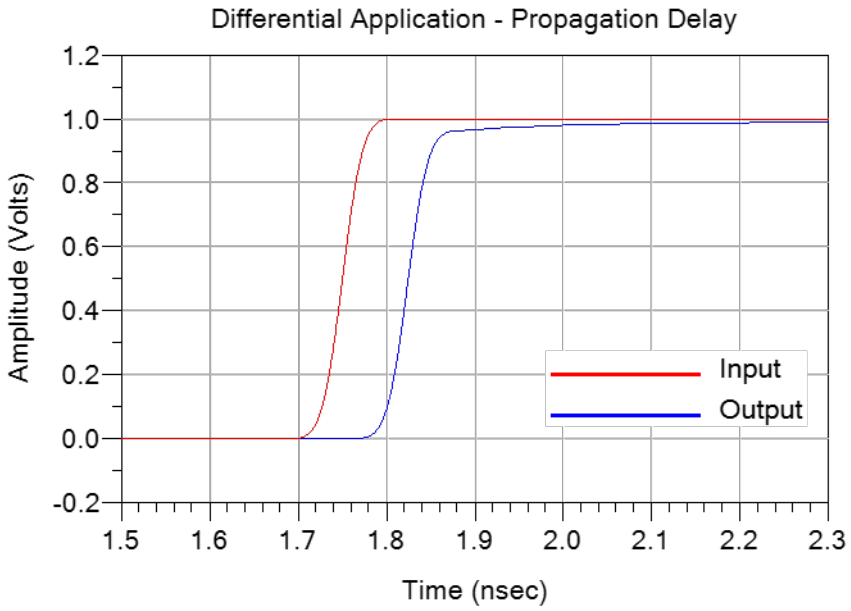
NVAM_B18, B19_ NVAF_B18, B19



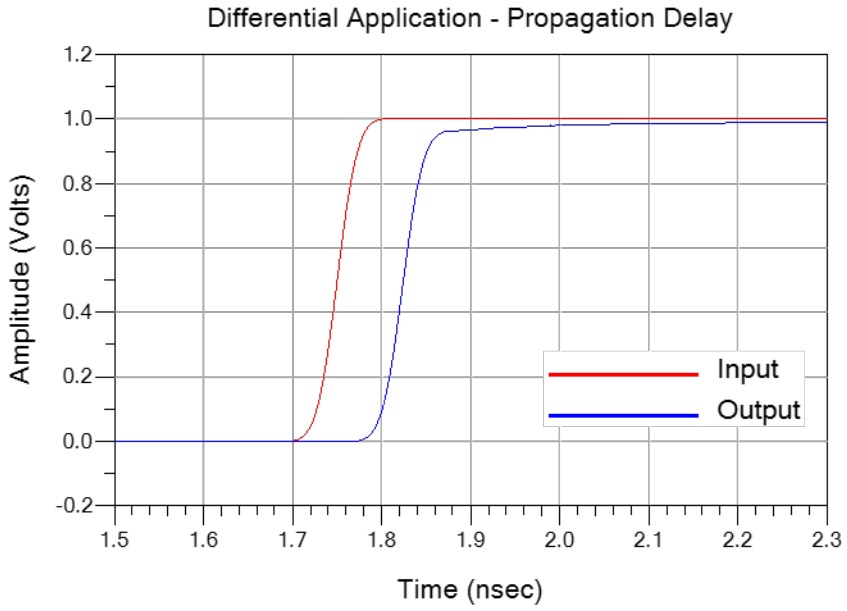
Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Differential Application – Propagation Delay

NVAM_A6, A7_ NVAF_A6, A7

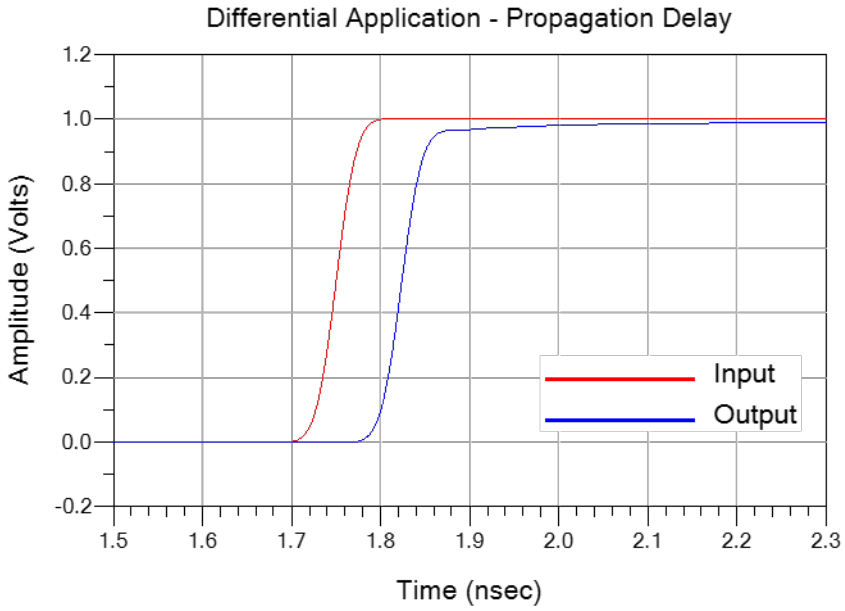


NVAM_A10, A11_ NVAF_A10, A11

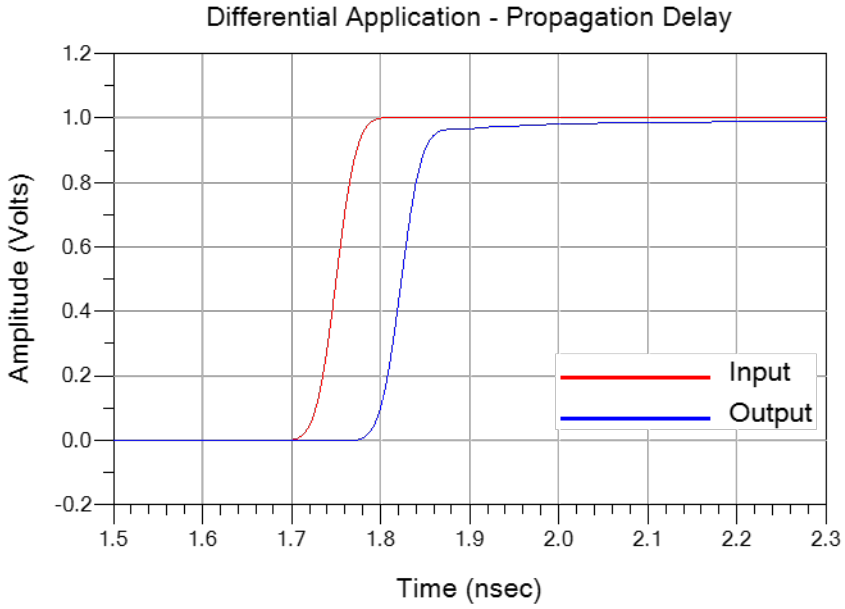


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

NVAM_A14, A15_ NVAF_A14, A15

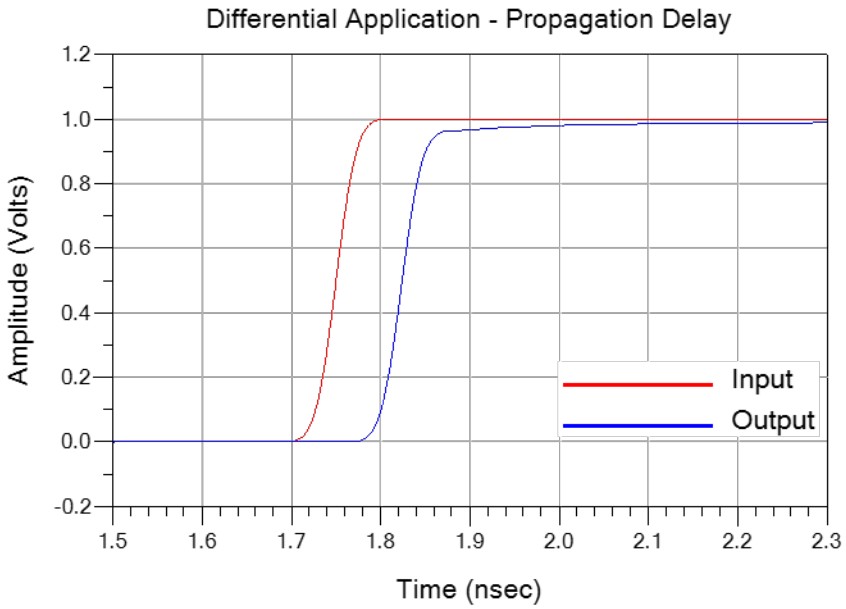


NVAM_A18, A19_ NVAF_A18, A19

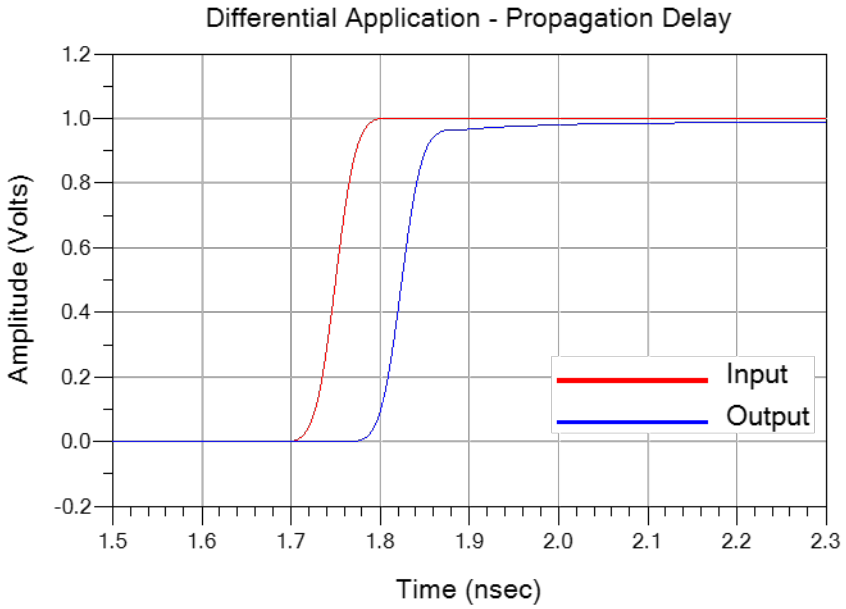


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

NVAM_B6, B7_ NVAF_B6, B7

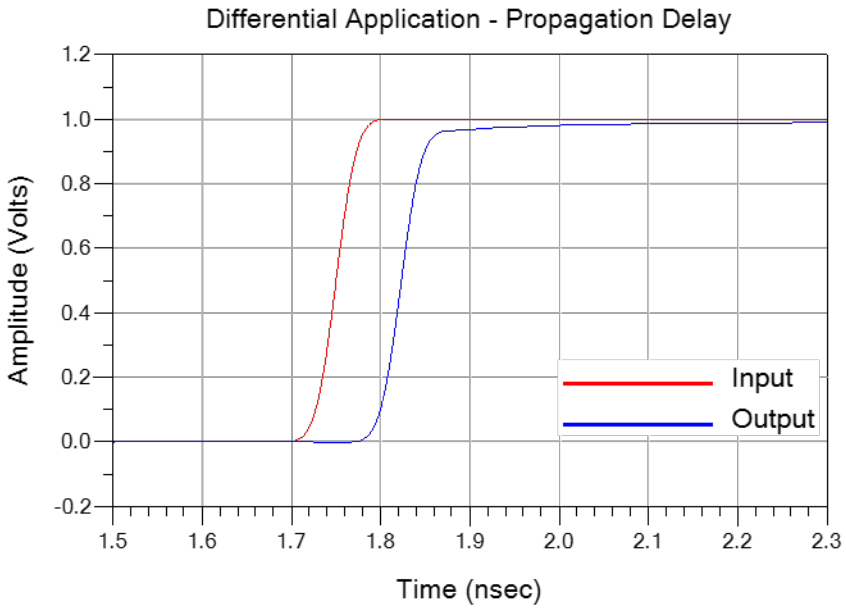


NVAM_B10, B11_ NVAF_B10, B11

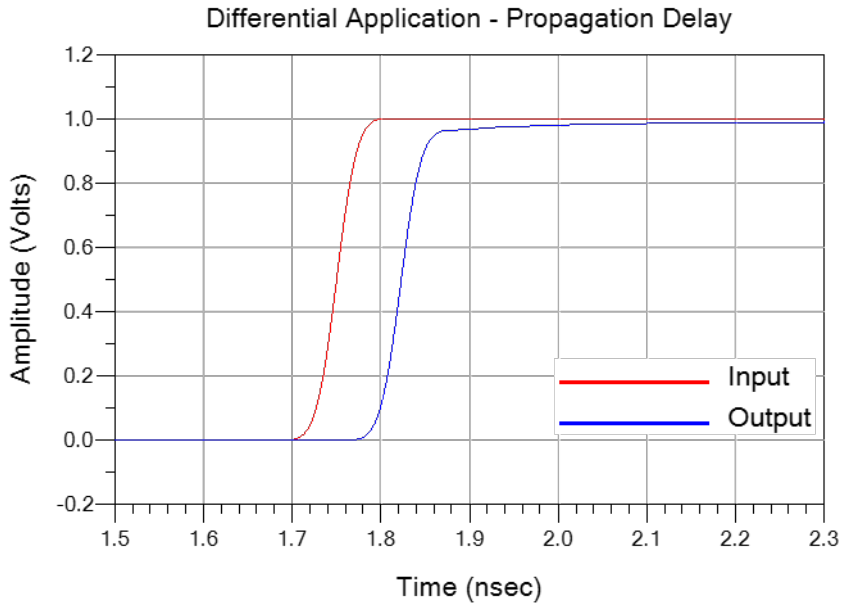


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

NVAM_B14, B15_ NVAF_B14, B15

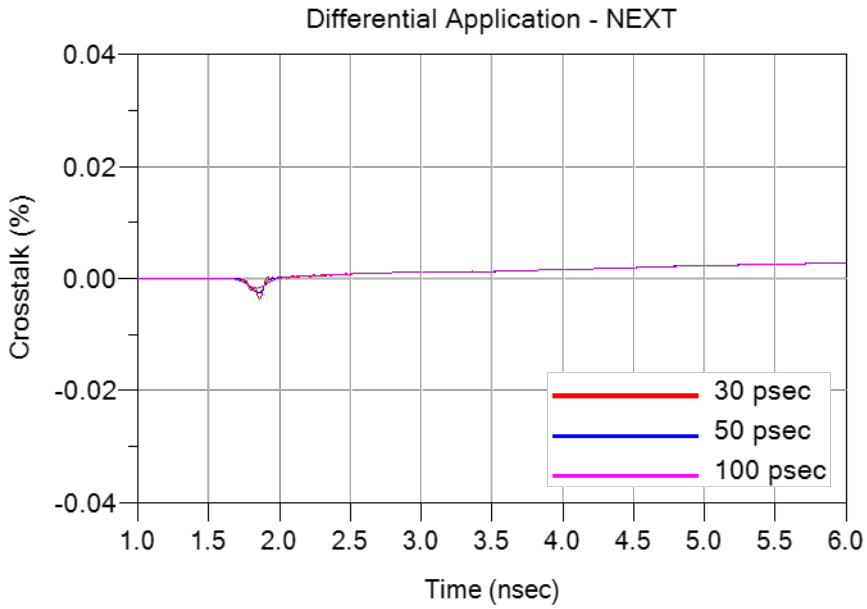


NVAM_B18, B19_ NVAF_B18, B19

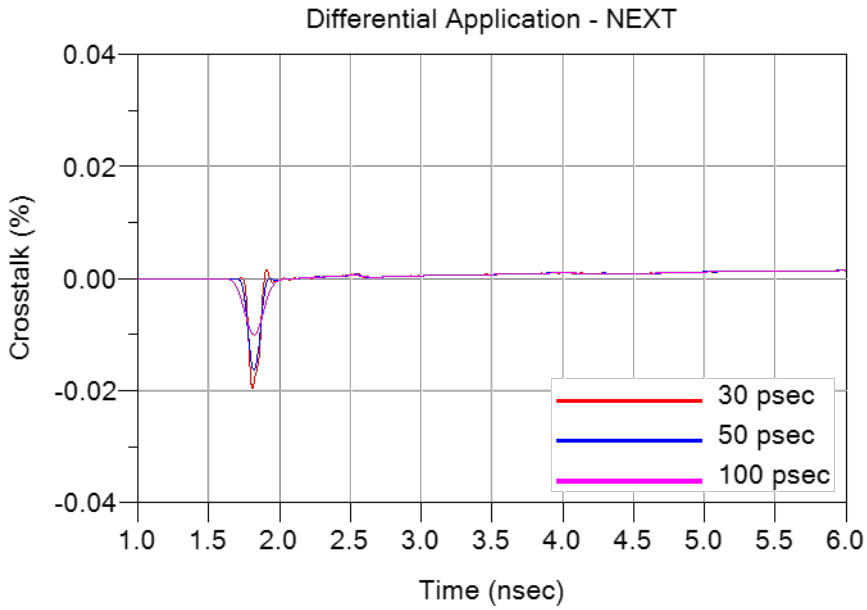


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Differential Application – NEXT, NVAM_B6B7_NVAM_A10A11

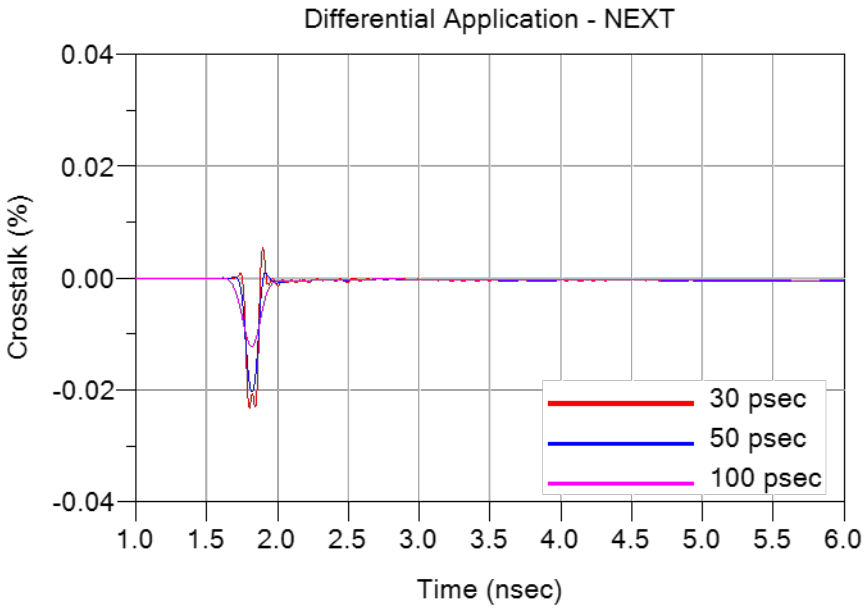


Differential Application – NEXT, NVAM_B10B11_NVAM_A10A11

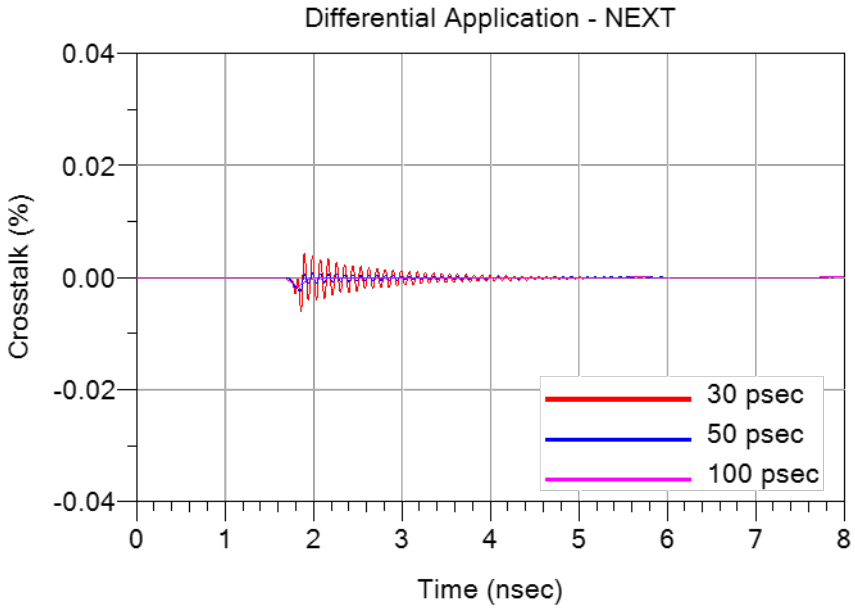


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Differential Application – NEXT, NVAM_B14B15_NVAM_A10A11

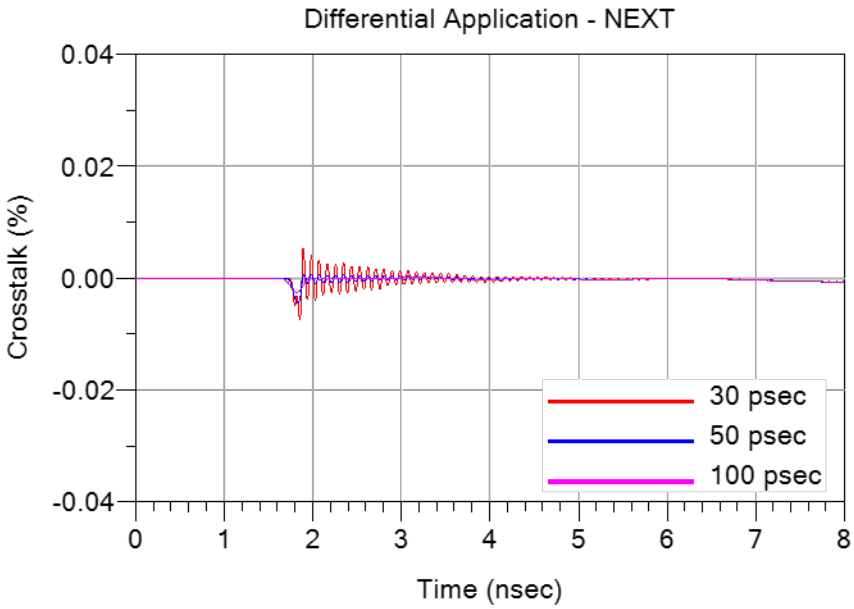


Differential Application – NEXT, NVAM_A18A19_NVAM_A14A15

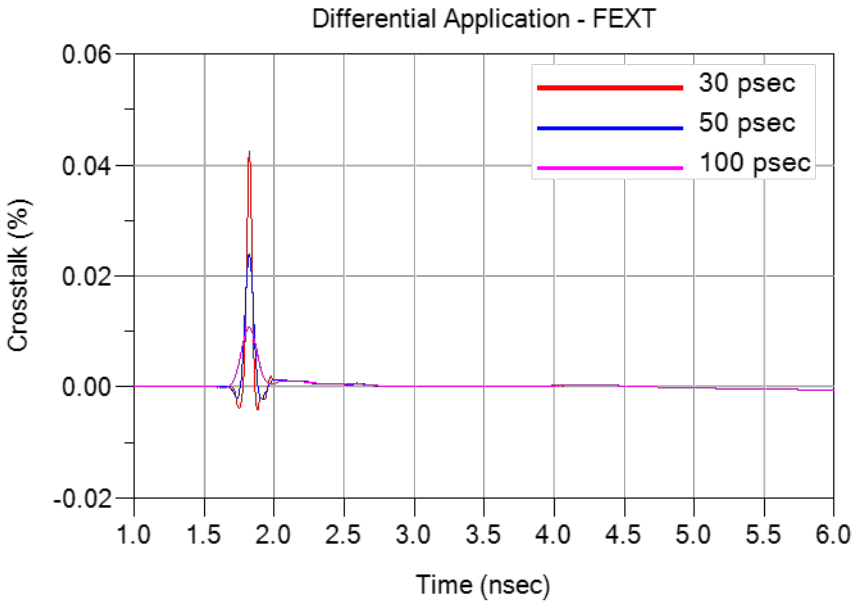


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Differential Application – NEXT, NVAM_B18B19_NVAM_A14A15

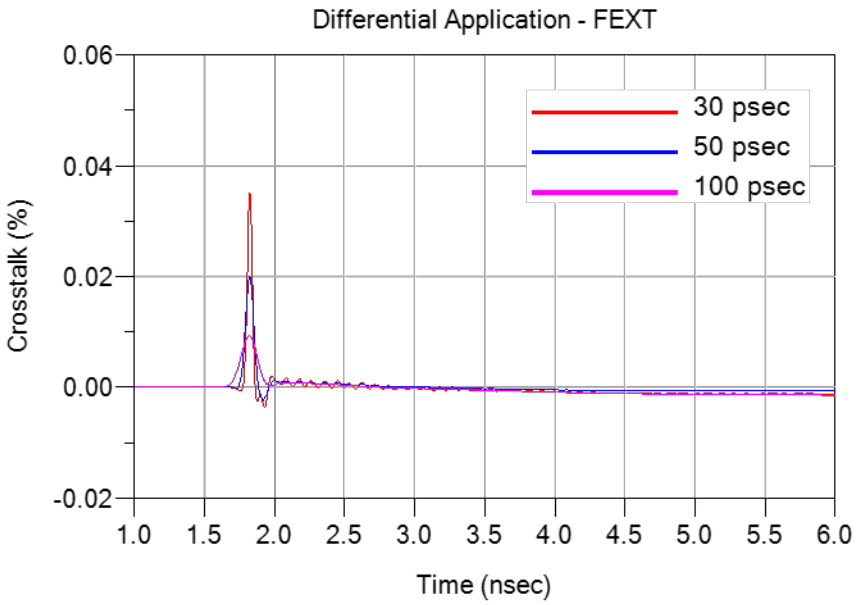


Differential Application – FEXT, NVAF_A6A7_NVAM_A10A11

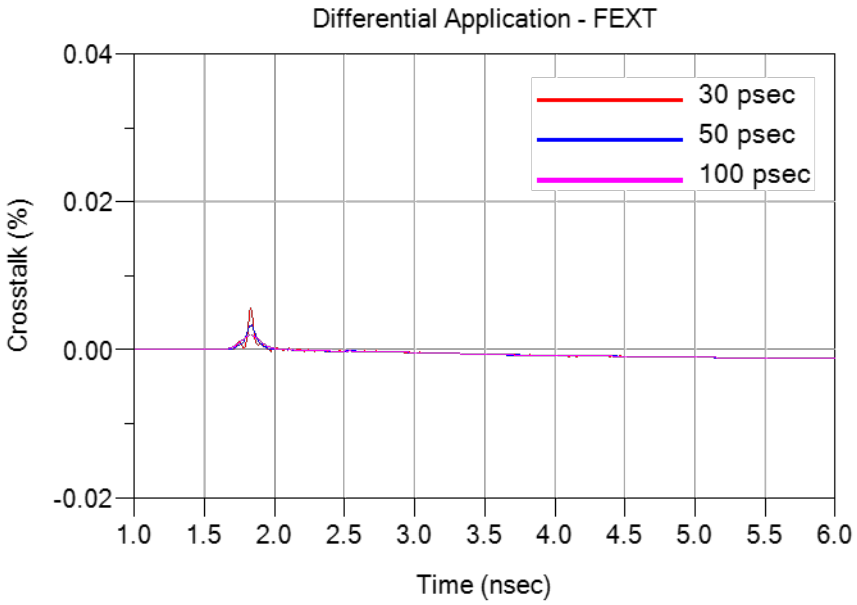


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Differential Application – FEXT, NVAF_A14A15_NVAM_A10A11

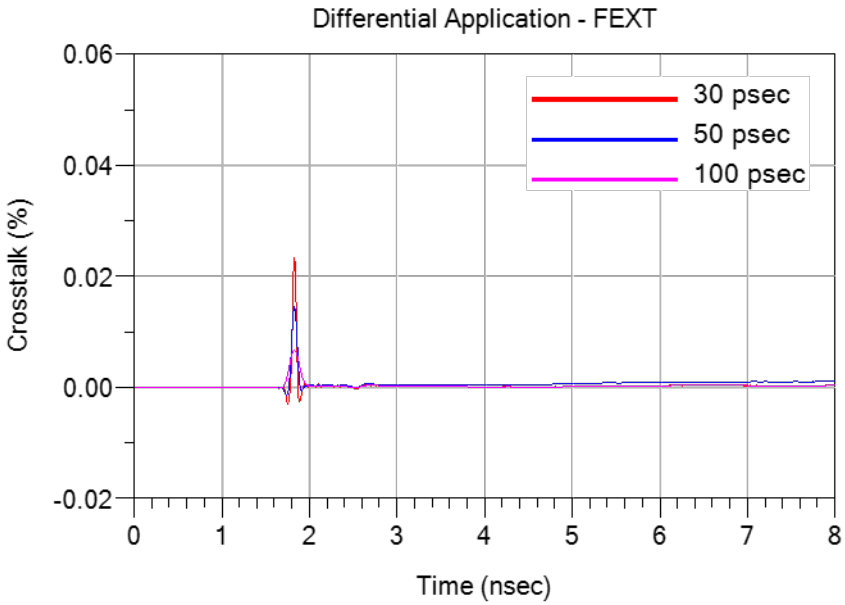


Differential Application – FEXT, NVAF_B6B7_NVAM_A10A11

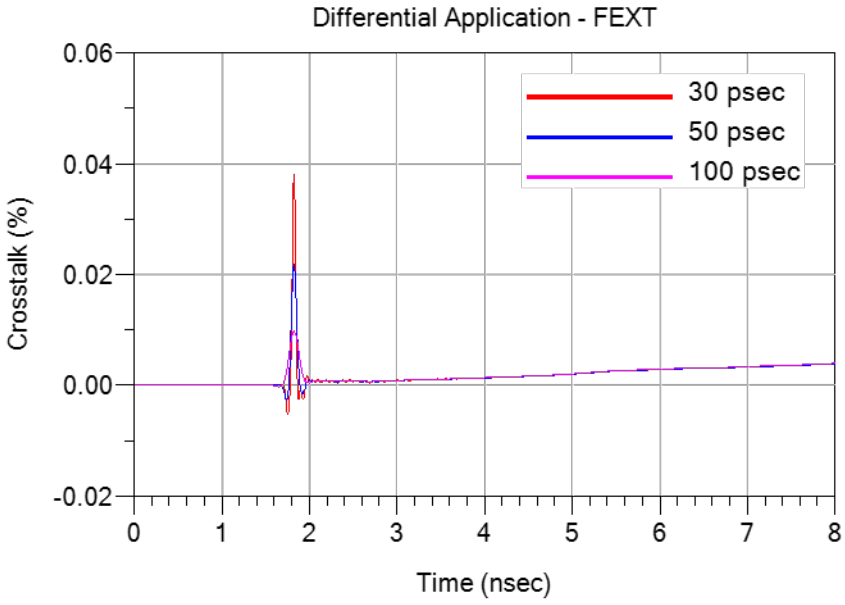


Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Differential Application – FEXT, NVAF_B10B11_NVAM_A10A11



Differential Application – FEXT, NVAF_B14B15_NVAM_A10A11



Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Appendix C – Product and Test System Descriptions

Product Description

Product test samples are NVAx Series connectors. The part number is NVAM-DP-02-2-02.0-S-2-C and NVAF-DP-02-2-05.0-S-2. A photo of the test articles mounted to SI test boards is shown below.

Test System Description

The test fixtures are composed of six-layer TACHYON 100G material with 46.25Ω signal trace and pad configurations designed for the electrical characterization of Samtec high speed connector products. A PCB mount 2.4mm connector is used to interface the PNA test cables to the test fixtures. Optimization of the 2.4mm launch was performed using full wave simulation tools to minimize reflections. The test fixtures and calibration kit are specific to the NVAx series connector set and identified by part number PCB-109157-SIG-XX.

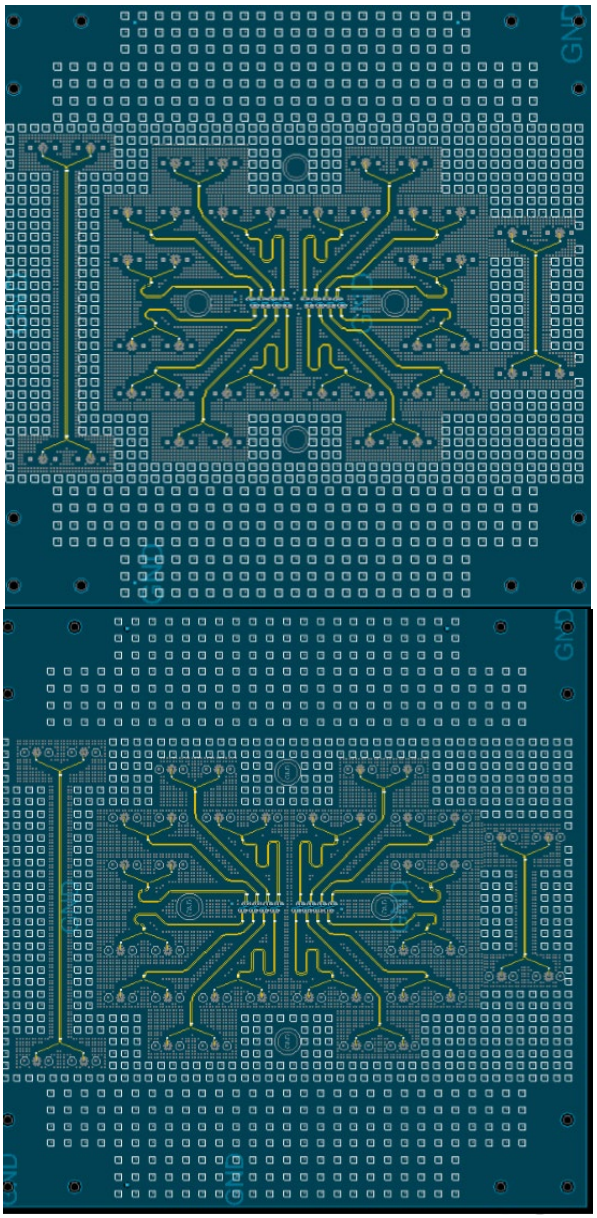
PCB-109157-SIG-XX Test Fixtures

Shown below is a photograph of the one of the three test board sets.

Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

PCB Fixtures

The test fixtures used are as follows:

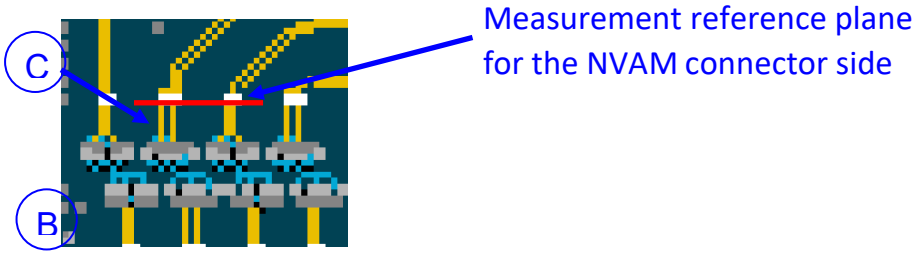


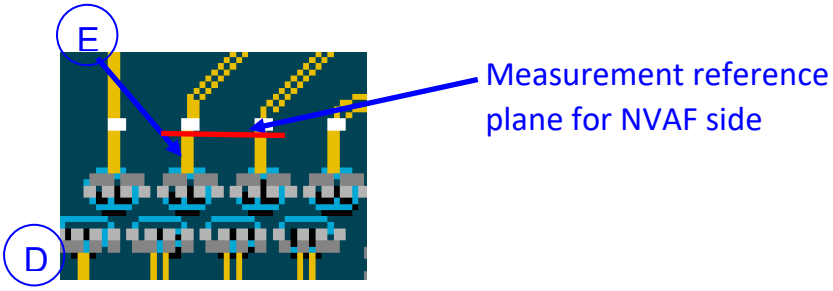
Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

All traces on the test boards are length matched to 53.2 mm measured from the edge of the pad to the 2.4mm connector. The AFR calibration effectively removes 50.263 mm of test board trace effects. This means that 2.937 mm of test board trace length effects are included in the both sides of test boards in the measurement. The S-Parameter measurement includes:

A- The NVAx Series connector set
B- Test board vias, pads (footprint effects) for the NVAM connector side.
C- 2.937 mm of 0.148 mm wide microstrip trace.
D- Test board vias, pads (footprint effects) for the NVAF side.
E- 2.937 mm of 0.148 mm wide microstrip trace.

The figure below shows the location of the measurement reference plane.





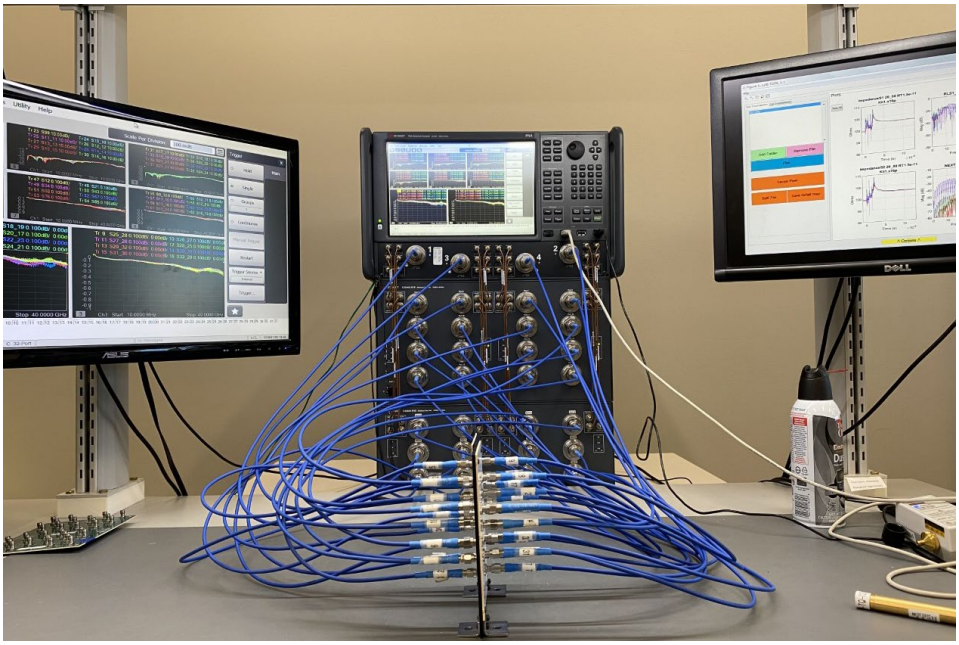
Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Appendix D – Test and Measurement Setup

For frequency domain measurements, the test instrument is the Keysight N5227A PNA-L network analyzer. Frequency domain data are obtained directly from the instrument and figures are generated by Keysight ADS. The network analyzer is configured as follows:

Start Frequency – 10 MHz
Stop Frequency – 50 GHz
Number of points – 5000
IFBW – 1 KHz

N5227A Measurement Setup



Test Instruments

QTY	Description
1	Keysight N5227A PNA-L Network Analyzer (10 MHz to 50 GHz)
1	Keysight Maury 8770D 2.4mm Module (10 MHz to 50 GHz)

Test Cables & Adapters

QTY	Description
4	Junkosha 2.4mm Instrumentation cables

Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Appendix E - Frequency and Time Domain Measurements

Frequency (S-Parameter) Domain Procedures

The quality of any data taken with a network analyzer is directly related to the quality of the calibration standards and the use of proper test procedures. For this reason, extreme care is taken in the design of the through calibration standards, the SI test boards, and the selection of the PCB vendor.

A coaxial SOLT calibration is performed using 8770D ECAL module. Then DUT measurements are performed under SOLT calibration. The measurements include the effect of test fixture. The measurements of the 2X THRU line standards are required to remove the test fixture effect.

Time Domain Procedures

Mathematically, Frequency Domain data can be transformed to obtain a Time Domain response. Perfect transformation requires Frequency Domain data from DC to infinity Hz. Fortunately, a very accurate Time Domain response can be obtained with bandwidth-limited data, such as measured with modern network analyzer.

The Time Domain responses were generated using Keysight ADS 2017. This tool has a transient convolution simulator, which can generate a Time Domain response directly from measured S-Parameters. An example of a similar methodology is provided in the Samtec Technical Note on domain transformation.
http://www.samtec.com/Technical_Library/reference/articles/pdfs/tech-note_using-PLTS-for-time-domain-data_web.pdf

Impedance (TDR)

A step pulse is applied to the touchstone model of the connector and the reflected voltage is monitored. The reflected voltage is converted to a reflection coefficient and then transformed into an impedance profile. All ports of the Touchstone model are terminated in 50 ohms.

Propagation Delay (TDT)

The Propagation Delay is a measure of the Time Domain delay through the connector and footprint. A step pulse is applied to the touchstone model of the connector and the transmitted voltage is monitored. The same pulse is also applied to a reference channel with zero loss, and the Time Domain pulses are plotted on the same graph. The difference in time, measured at the 50% point of the step voltage is the propagation delay.

Series: NVAM / NVAF
Description: 0.80 mm NovaRay® Extreme Density & Performance Connector, 7mm Stack Height

Appendix F – Glossary of Terms

ADS – Advanced Design Systems
FD – Frequency domain
FEXT – Far-End Crosstalk
GSG – Ground–Signal-Ground; geometric configuration
GSSG - Ground–Signal-Signal-Ground; geometric configuration
NEXT – Near-End Crosstalk
PCB – Printed Circuit Board
SE – Single-Ended
SI – Signal Integrity
SOLT – acronym used to define Short, Open, Load & Thru Calibration Standards
TD – Time Domain
TDA – Time Domain Analysis
TDR – Time Domain Reflectometry
TDT – Time Domain Transmission
Z – Impedance (expressed in ohms)